



THDT6511D

Application Specific Discretes TRANSIENT VOLTAGE SUPPRESSOR A.S.D.™ FOR SLIC PROTECTION

FEATURES

- DUAL ASYMETRICAL TRANSIENT SUPPRESSOR
- PEAK PULSE CURRENT : $I_{PP} = 40A$, 10/100 μs
- HOLDING CURRENT : 150 mA min.
- BREAKDOWN VOLTAGE : 65 V min.
- LOW DYNAMIC CHARACTERISTICS
- STAND CCITT K20 AND LSSGR

DESCRIPTION

This device has been especially designed to protect subscriber line cards against overvoltage.

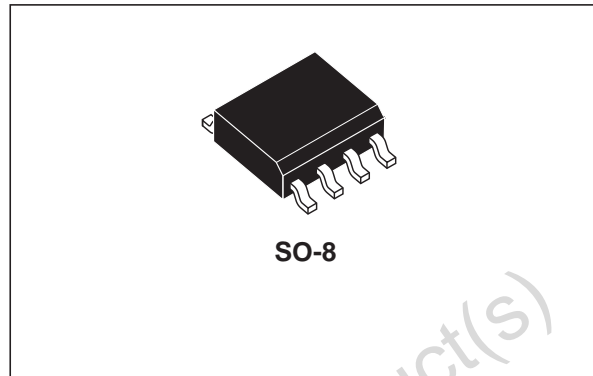
Two diodes clamp positive overloads while negative surges are suppressed by two protection thyristors.

A particular attention has been given to the internal wire bonding. The "4-point" configuration ensures a reliable protection, eliminating overvoltages introduced by the parasitic inductances of the wiring (Ldi/dt), especially for very fast transient overvoltages.

COMPLIES WITH THE FOLLOWING STANDARDS :

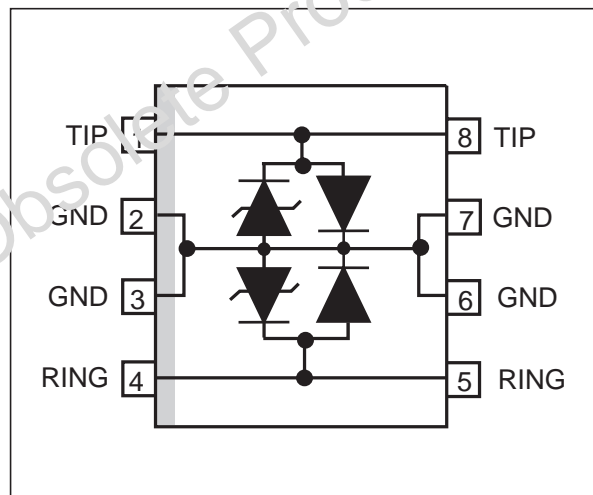
CCITT K20 :	10/700 μs	1kV
	5/310 μs	38A
VDE 0433 :	10/700 μs	2kV
	5/310 μs	50A
VDE 0878 :	1.2/50 μs	1.5kV
	1/20 μs	40A
I3124 :	0.5/700 μs	1kV
	0.2/310 μs	38A
FCC part 68 :	2/10 μs	2.5kV
	2/10 μs	125A (*)
BELLCORE TR-NWT-001089 :	2/10 μs	2.5kV
	2/10 μs	125A (*)
	10/1000 μs	1kV
	10/1000 μs	40A (*)

(*) with series resistors or PTC.



SO-8

SCHEMATIC DIAGRAM



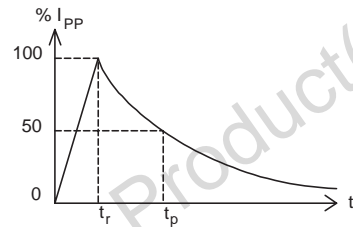
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ABSOLUTE MAXIMUM RATINGS (T_{amb} = 25°C)

Symbol	Parameter	Value	Unit	
I _{PP}	Peak pulse current (see note 1)	10/1000μs 5/310μs 2/10μs	40 50 125	A
I _{TSM}	Non repetitive surge peak on-state current F = 50 Hz	t = 300 ms t = 1 s t = 5 s	10 3.5 1	A
I _{TSM}	F = 50 Hz, 60 x 1 s, 2 mn between pulse		1	A
T _{stg} T _j	Storage temperature range Maximum junction temperature		- 55 to + 150 150	°C
T _L	Maximum lead temperature for soldering during 10s		260	°C

Note 1 : Pulse waveform :

10/1000μs	t _r =10μs	t _p =1000μs
5/310μs	t _r =5μs	t _p =310μs
2/10μs	t _r =2μs	t _p =10μs



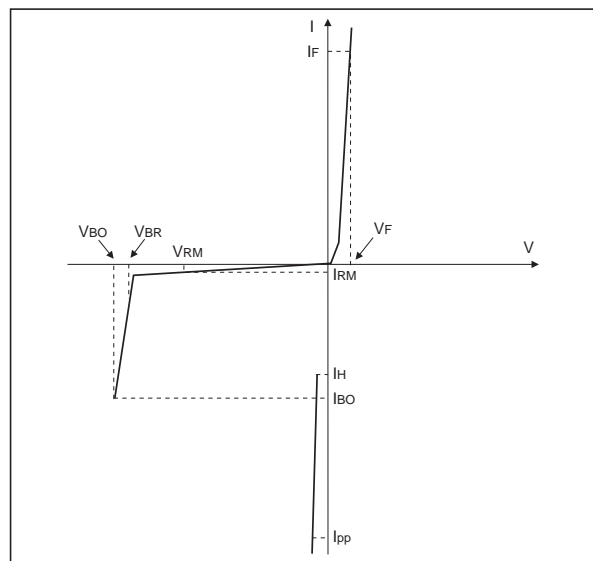
THERMAL RESISTANCES

Symbol	Parameter	Value	Unit
R _{th(j-a)}	Junction to ambient	170	°C/W

ELECTRICAL CHARACTERISTICS

(T_{amb} = 25°C)

Symbol	Parameter
V _{RM}	Stand-off voltage
I _{RM}	Leakage current at stand-off voltage
V _{BR}	Breakdown voltage
V _{BO}	Breakover voltage
I _H	Holding current
V _F	Forward voltage drop
V _{FP}	Peak forward voltage
I _{BO}	Breakover current
I _{PP}	Peak pulse current
C	Capacitance
αT	Temperature coefficient



1 - PARAMETERS RELATED TO DIODE LINE / GND

Symbol	Test conditions	Min.	Typ.	Max.	Unit
V_F	$I_F = 1 \text{ A}$ $t_p = 100 \mu\text{s}$			2	V
V_{FP}	see curve fig. 1	NA	NA	NA	V

NA : Non Available

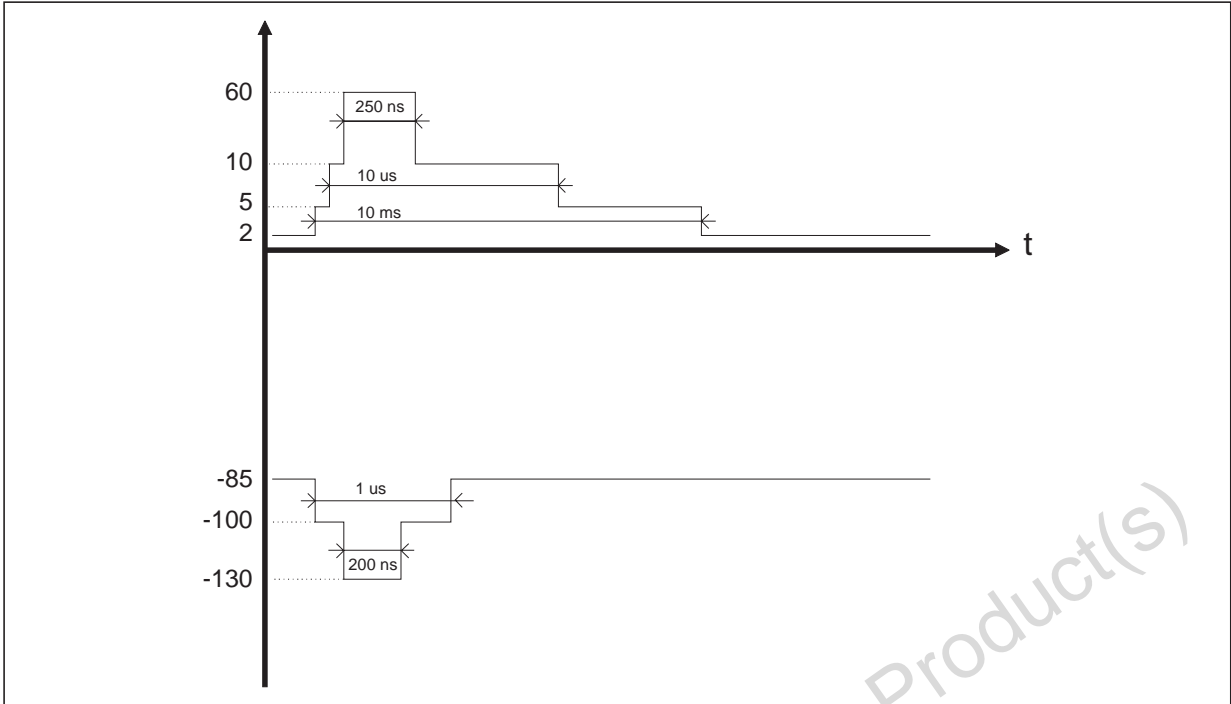
2 - PARAMETERS RELATED TO PROTECTION THYRISTOR

Symbol	Tests conditions	Min.	Typ.	Max.	Unit
V_{BR}	$I_R = 1 \text{ mA}$	65			V
V_{BO}		68		85	V
I_{RM}	$V_{RM} = 63 \text{ V}$			100	μA
I_{BO}	$t_p = 100 \mu\text{s}$	110		450	mA
I_{BO}	$F = 50 \text{ Hz}$ $R_G = 600 \Omega$			500	mA
I_H		150			mA
αT			15		$10^{-4}/^\circ\text{C}$
C	$V_D = 100 \text{ mV}_{RMS}$ $F = 1 \text{ KHz}$			500	pF
dV/dt	Linear ramp up to 67 % of V_{BR}	5			kV / μs

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DYNAMIC CHARACTERISTICS : V_{FP} and V_{BO}

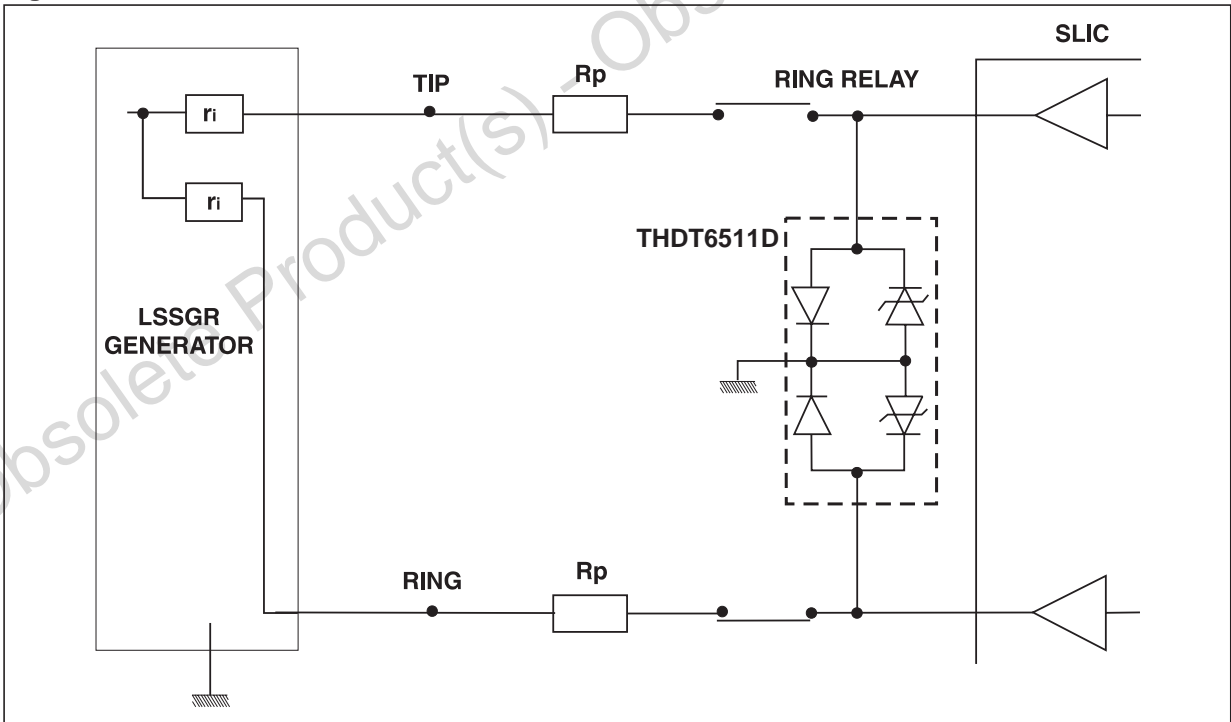
Figure 1 :



Under lightning and power crossing test, the device limits the transient voltage to the values indicated in the figure

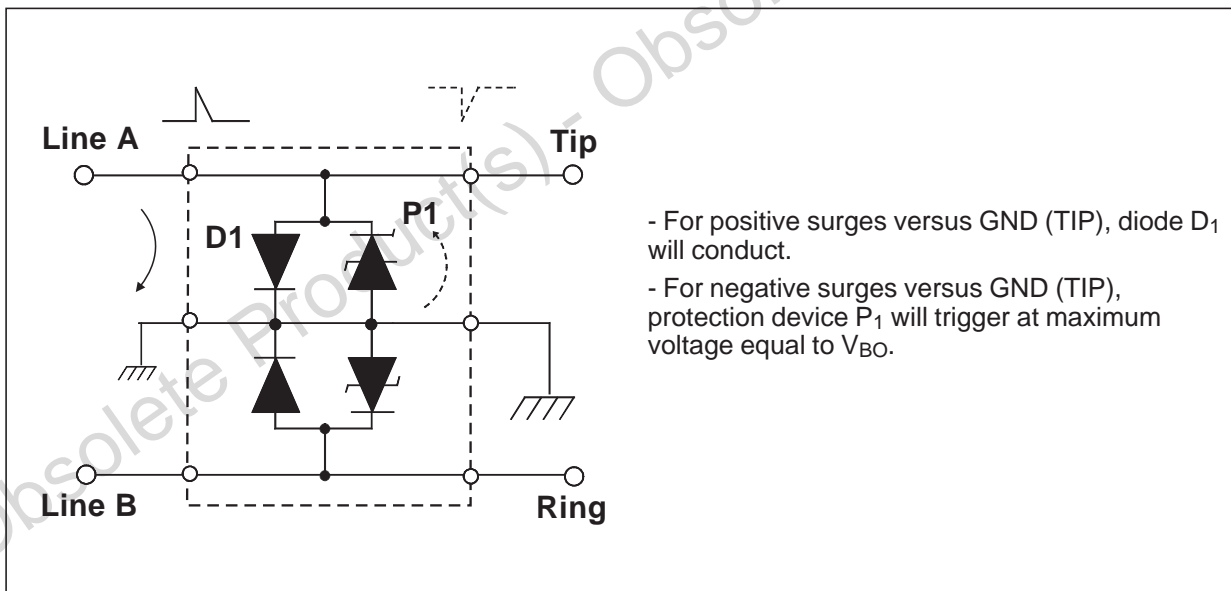
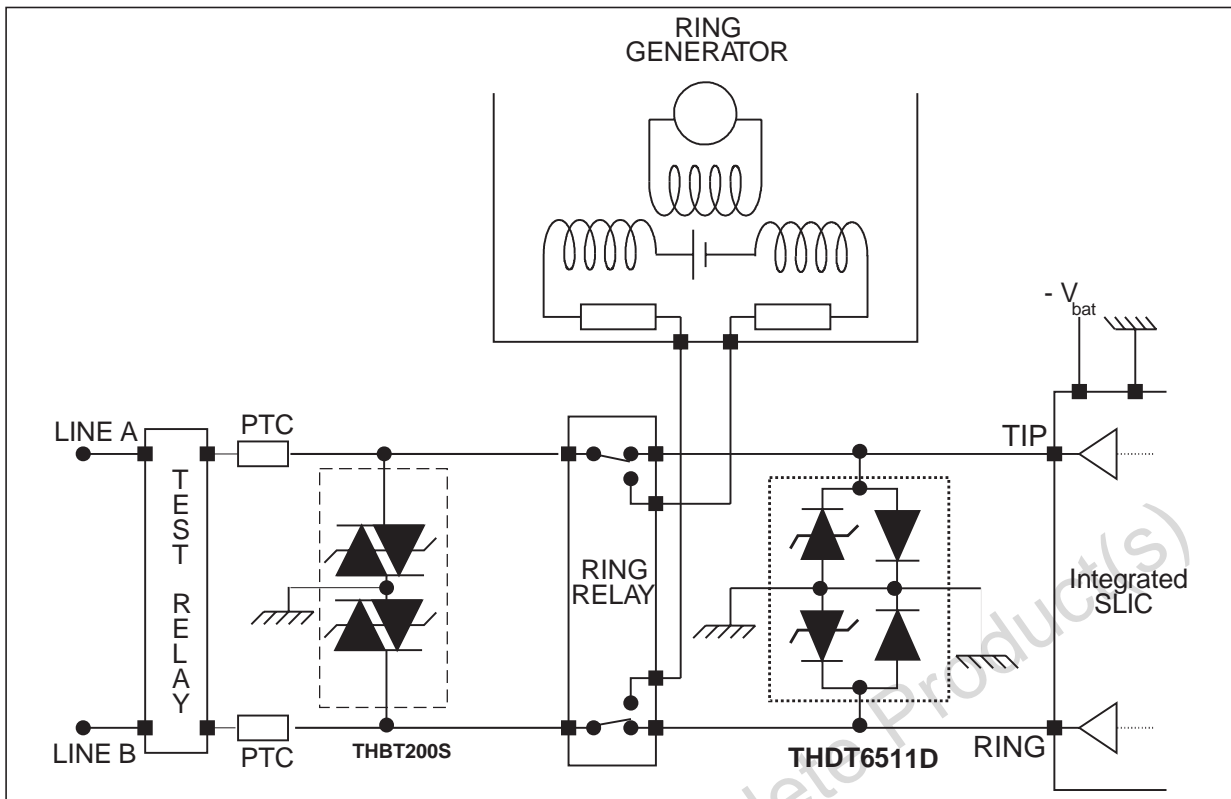
LSSGR TEST DIAGRAM

Figure 2 :



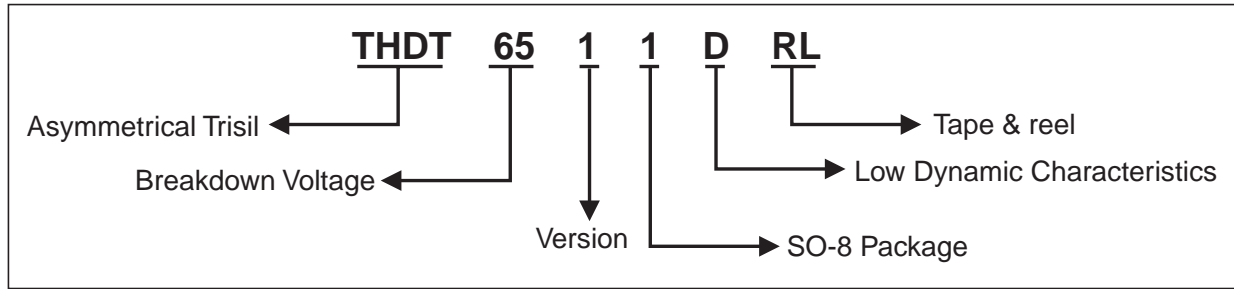
To stand the LSSGR test requirements, Rp must be | 15 Ω

TYPICAL APPLICATION

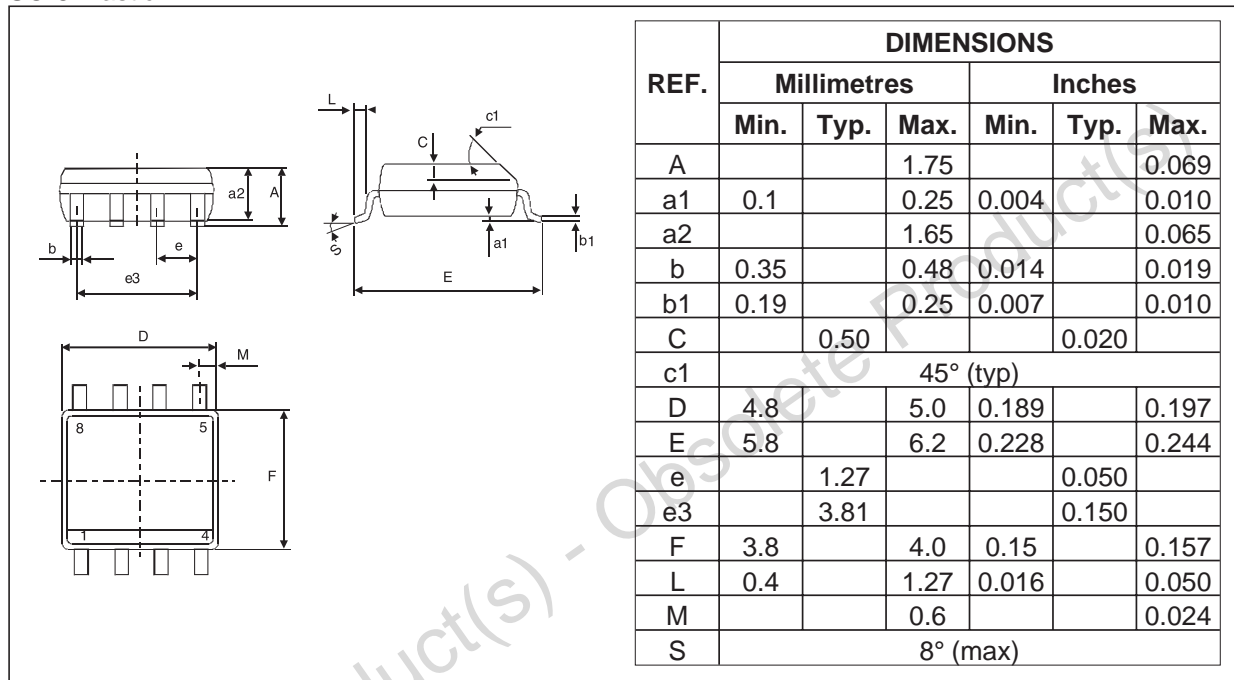


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ORDER CODE



PACKAGE MECHANICAL DATA. SO-8 Plastic



MARKING : DT651D

PACKAGING : Products supplied in antistatic tube or tape and reel.

Weight : 0.08g

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